



Connectors > Socket Connectors > Memory Sockets > SO DIMM Sockets > DDR2 SO DIMM Sockets



DRAM Type: **Double Data Rate (DDR) 2**

Stack Height: **4 mm [ .157 in ]**

Module Orientation: **Right Angle**

PCB Mounting Style: **Surface Mount**

Connector System: **Cable-to-Board**

[All DDR2 SO DIMM Sockets \(30\)](#)

## Features

### Product Type Features

DRAM Type	Double Data Rate (DDR) 2
Connector System	Cable-to-Board
Sealable	No
Connector & Contact Terminates To	Printed Circuit Board
Product Type	Socket

### Configuration Features

Number of Bays	2
Center Key	Offset Right
Number of Keys	1
Module Orientation	Right Angle
Number of Positions	200
Number of Rows	2
Keying	Reverse

### Electrical Characteristics

DRAM Voltage	1.8 V
--------------	-------

### Signal Characteristics

SGRAM Voltage	1.8 V
---------------	-------



### Body Features

Ejector Location	Both Ends
Latch Material	Stainless Steel
Latch Plating Material	Tin
Module Key Type	SGRAM
Ejector Type	Locking
Connector Profile	Standard

### Contact Features

Socket Style	SO DIMM
PCB Contact Termination Area Plating Material	Gold Flash
Contact Base Material	Copper Alloy
Contact Mating Area Plating Material	Gold Flash
Contact Current Rating (Max)	.5 A
Socket Type	Memory Card

### Termination Features

Insertion Style	Cam-In
-----------------	--------

### Mechanical Attachment

PCB Mount Retention	With
PCB Mount Retention Type	Solder Peg
PCB Mounting Style	Surface Mount
Connector Mounting Type	Board Mount

### Housing Features

Centerline (Pitch)	.6 mm [.024 in]
Housing Color	Black
Housing Material	High Temperature Thermoplastic

### Dimensions

Stack Height	4 mm [.157 in]
Row-to-Row Spacing	5.8 mm [.228 in]

### Usage Conditions

Operating Temperature Range	-55 – 85 °C [-67 – 185 °F]
-----------------------------	----------------------------

### Operation/Application



Circuit Application	Power
---------------------	-------

### Industry Standards

UL Flammability Rating	UL 94V-0
------------------------	----------

### Packaging Features

Packaging Method	Reel
------------------	------

Packaging Quantity	200
--------------------	-----

### Product Compliance

[For compliance documentation, visit the product page on TE.com>](#)

EU RoHS Directive 2011/65/EU	Compliant
------------------------------	-----------

EU ELV Directive 2000/53/EC	Compliant
-----------------------------	-----------

China RoHS 2 Directive MIIT Order No 32, 2016	No Restricted Materials Above Threshold
---	---

EU REACH Regulation (EC) No. 1907/2006	Current ECHA Candidate List: JUNE 2022 (224) Candidate List Declared Against: JUL 2021 (219) SVHC > Threshold: Not Yet Reviewed
--	--

Halogen Content	Low Halogen - Br, Cl, F, I < 900 ppm per homogenous material. Also BFR/CFR/PVC Free
-----------------	---

Solder Process Capability	Not reviewed for solder process capability
---------------------------	--

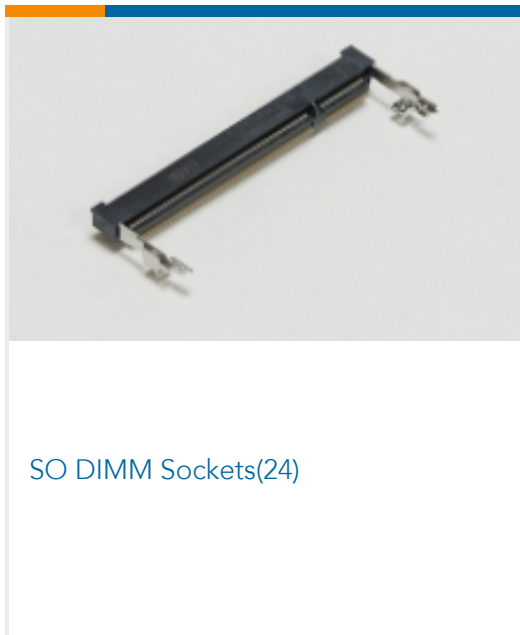
#### Product Compliance Disclaimer

This information is provided based on reasonable inquiry of our suppliers and represents our current actual knowledge based on the information they provided. This information is subject to change. The part numbers that TE has identified as EU RoHS compliant have a maximum concentration of 0.1% by weight in homogenous materials for lead, hexavalent chromium, mercury, PBB, PBDE, DBP, BBP, DEHP, DIBP, and 0.01% for cadmium, or qualify for an exemption to these limits as defined in the Annexes of Directive 2011/65/EU (RoHS2). Finished electrical and electronic equipment products will be CE marked as required by Directive 2011/65/EU. Components may not be CE marked. Additionally, the part numbers that TE has identified as EU ELV compliant have a maximum concentration of 0.1% by weight in homogenous materials for lead, hexavalent chromium, and mercury, and 0.01% for cadmium, or qualify for an exemption to these limits as defined in the Annexes of Directive 2000/53/EC (ELV). Regarding the REACH Regulation, the information TE provides on SVHC in articles for this part number is based on the latest European Chemicals Agency (ECHA) 'Guidance on requirements for substances in articles' posted at this URL: <https://echa.europa.eu/guidance-documents/guidance-on-reach>

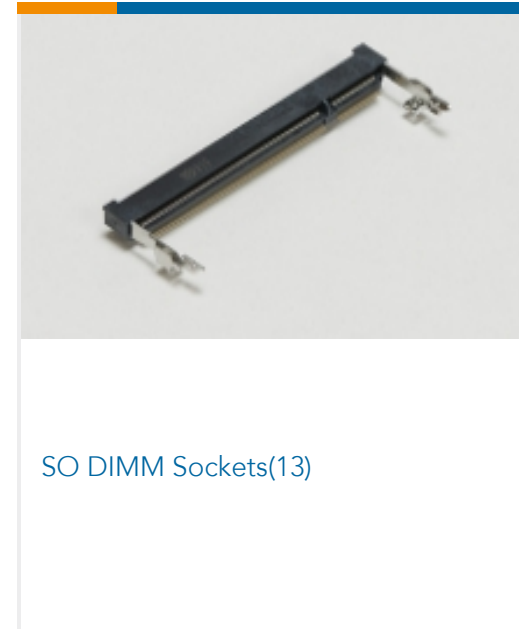
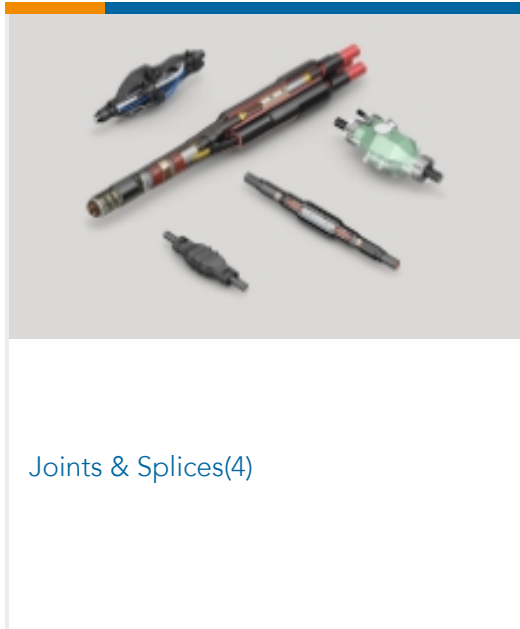
### Compatible Parts



### Also in the Series | **DDR2 SO DIMM**



### Also in the Series | **Raychem RVS**



### Customers Also Bought



### Documents

#### Product Drawings

**EMBOSS DDR2 SODIMM 200P 4H RVS**

English

#### CAD Files



### Customer View Model

[ENG\\_CVM\\_CVM\\_292407-4\\_B1.2d\\_dxf.zip](#)

English

[3D PDF](#)

3D

### Customer View Model

[ENG\\_CVM\\_CVM\\_292407-4\\_B1.3d\\_igs.zip](#)

English

### Customer View Model

[ENG\\_CVM\\_CVM\\_292407-4\\_B1.3d\\_stp.zip](#)

English

By downloading the CAD file I accept and agree to the [Terms and Conditions](#) of use.

---

### Product Specifications

[Product Specification](#)

English

---

### Product Environmental Compliance

[TE Material Declaration](#)

English